

Additive Manufacturing: Standards & Other International Trends

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University of Louisville's Involvement in AM

- One of the best equipped additive manufacturing (AM) facilities in the world
- Performing federally-funded basic and applied research, technology transfer, and industry-funded projects *in AM since starting with SLS in 1993*
- Over 20 people focused on AM
- Partner of leading AM users
 - Boeing, GE, DoD, Integra, service bureaus, etc.
- Over 70 member organizations in our RP Center
 - Includes Haas Technical Education Center



AM Equipment at UL

• Polymer Laser Sintering (LS)

- 3D Systems (DTM) 2500 plus (with Multi-zone heating)
- 3D Systems (DTM) 2500CI High Temperature Research Platform
 - Multi-zone heating
 - High Speed Scanning
- Direct Metal Laser Sintering (DMLS)
 - EOS M270 Dual Mode
- Electron Beam Melting (EBM)
 - Arcam S400
- ExOne 3D Printing
 - Dental machine

- Ultrasonic Consolidation (UC)
 - Fabrisonic R200 High Power
 - Solidica Formation Beta Machine
- Laser Engineered Net Shaping
 - Optomec LENS 850
- Fused Deposition Modeling
 - Stratasys uPrint
 - Several desktop, educational "material extrusion" machines
- Stereolithography
 - 3D Systems SLA 250/30
- Direct Write
 - nScrypt Direct Write head



Some of the On-Going AM Research at UofL

- Navy-funded work
 - Modeling and control of Ultrasonic Consolidation
 - Comprehensive materials testing of metals and polymers made using UC, SLS, DMLS, EBM & FDM
 - Development of a material for accurate magnetic scale models
- Air Force-funded work
 - Modeling of metal laser sintering of Ti 6/4
 - Thermal understanding and control in polymer laser sintering
- NSF-funded work
 - Modeling of Friction Surfacing of Inconel superalloys and Stainless Steels
- NIST-funded work
 - Modeling of metal laser sintering of Inconel 625
- Industry-funded work
 - Monitoring & layer-by-layer validation of parts made using DMLS



History of ASTM F42 Committee

- SME RTAM initiated planning May 2008
- Contact made with ASTM Int'l July 2008
-planning/organizational meetings
- 1st F42 Meeting May 27-28, 2009 Philadelphia
-meetings alternate between USA & Europe
- 8th Meeting January 15-16, 2013 Atlanta, GA
- 9th Meeting July 2012 (with ISO TC261) Nottingham, UK



Current Organizational Structure

- Main Committee Officers
 - Brent Stucker (University of Louisville), Chairman
 - Carl Dekker (Met-l-flo), Vice-Chairman
 - Chris Tuck (Loughborough University), Recording Secretary
 - Connie Phillips (NCMS), Membership Secretary
- Five Subcommittees
 - Test Methods (Jason Davidson, Chair)
 - Materials and Processes (Shane Collins, Chair)
 - Design (Evan Malone, Chair)
 - Terminology (Terry Wohlers, Chair)
 - U.S. TAG for ISO 261 (Mary Kinsella, Chair)



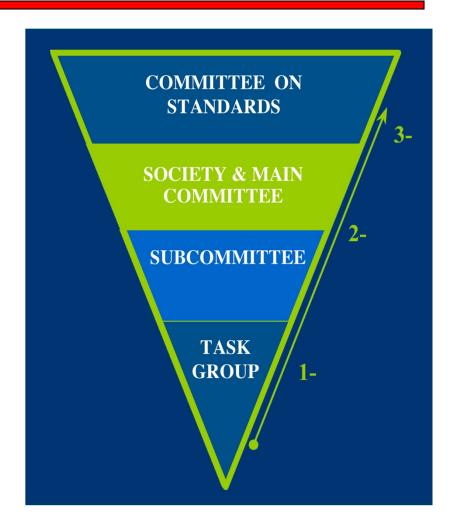
Committee Scope

- The promotion of *knowledge*, stimulation of *research* and *implementation of technology* through the development of standards for additive manufacturing technologies.
- The work of this Committee will be coordinated with other ASTM technical committees and other national and international organizations having mutual or related interests.



How standards are developed

- Drafted by Task Groups
- Balloted by Subcommittee
- Balloted by Main Committee
- Approved by ASTM





Key Accomplishments to Date

- Terminology
 - Including Process
 Category Names
- AMF File Format
- Testing Terminology
- Ti 6/4 Powder Bed Processing



General Observations of process

- Task Group Chair initiative is the key to success
- Create relatively complete draft standards quickly in small groups or as individuals
 - Circulate to Task Group (with deadline)
 - <u>Circulate to Subcommittee (with deadline)</u>
 - Ballot the proposed standard as soon as it is ready regardless of when that falls w.r.t. meetings
 - Ballot at subcommittee
 - Ballot at Main committee
 - sometime in parallel to subcommittee if it was revised based on input



Current State in ASTM F42

- Since 2009, F42 standards have been pursued using a bottom-up, needs-based approach
 - Self-organizing groups with common interests and needs working together to address their highest priority
- This was the correct approach for a new start-up standards organization
 - Got many people involved right away on subjects that they were passionate about (momentum, excitement)
 - Jump-started lots of industry engagement and quick progress on needed AM standards



International Standards Accomplishments this Year

- Terminology
 - Process Categories!
- Design
 - Updated AMF File Format
- Testing
 - Coordinate Systems & Part Location/Orientation
- Materials & Processes
 - Ti 6/4 Powder Bed Processing
- ISO TC 261
 - Signed agreement
 - Beginning adoption of ASTM standards



Vat Photopolymerization Process

• An additive manufacturing process in which liquid photopolymer in a vat is selectively cured by light-activated polymerization. (Reprinted, with permission from ASTM F2792-08. Copyright

ASTM International.)

- Stereolithography
- Envisiontec DLP
- Micro-SLA

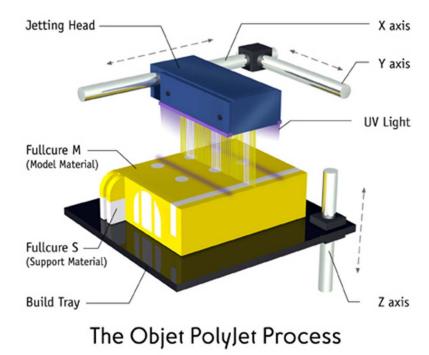


Material Jetting

• An additive manufacturing process in which droplets of build material are selectively deposited. (Reprinted, with

permission from ASTM F2792-08. Copyright ASTM International.)

- Wax or Photopolymers
- Multiple nozzles
- Single nozzles
- Includes
 - Objet
 - 3D Systems Projet
 - Stratasys Solidscape machines
 - Several Direct Write machines
 - Etc...





Binder Jetting

- An additive manufacturing process in which a liquid bonding agent is selectively deposited to join powder materials. (Reprinted, with permission from ASTM F2792-
 - 08. Copyright ASTM International.)
 - Zcorp
 - Voxeljet
 - ProMetal/ExOne





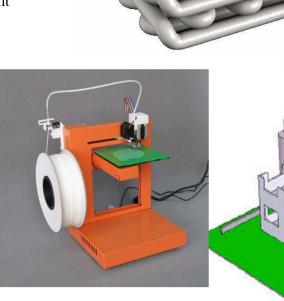


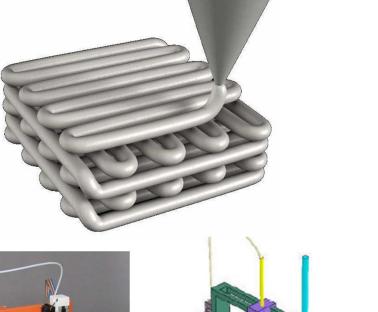
Material Extrusion

• An additive manufacturing process in which material is selectively dispensed through a nozzle or orifice.

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- Based on Stratasys FDM machines
- Office friendly
- DIY community
- Best selling platform







Powder Bed Fusion

• An additive manufacturing process in which thermal energy selectively fuses regions of a powder bed.

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- SLS, SLM, DMLS, EBM, BluePrinter, etc.
- Polymers, metals & ceramics







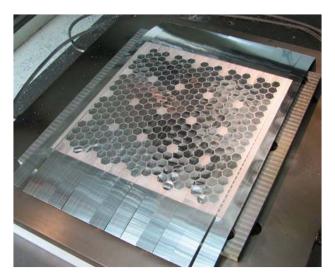
Sheet Lamination

• An additive manufacturing process in which sheets of material are bonded to form an

Object. (Reprinted, with permission from ASTM F2792-08. Copyright ASTM International.)

- Paper (LOM)
 - Using glue
- Plastic
 - Using glue or heat
- Metal
 - Using welding or bolts
 - Ultrasonic AM...





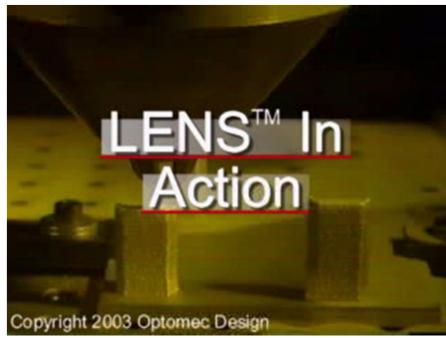


Directed Energy Deposition

Additive Manufacturing

• An additive manufacturing process in which focused thermal energy is used to fuse materials by melting as they are being deposited. (Reprinted, with permission from ASTM F2792-08. Copyright **ASTM** International.)





- Wire & Powder Materials
- Lasers & Electron Beams
- Great for feature addition & repair



AMF File format

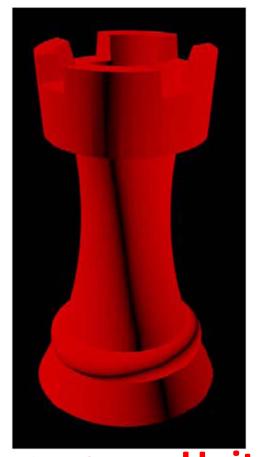
- .AMF
 - Additive Manufacturing Format
 - Additive Manufacturing File



- Open source license-free implementation
 - amf.wikispaces.com
- Next step is to work with software providers (like Microsoft & Materialise) to refine and implement the standard

```
<?xml version="1.0" encoding="UTF-8"?>
<amf units="mm">
  <object id="0">
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        <vertex>
          <coordinates>
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            <z>3.715</z>
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        </vertex>
        <vertex>
          <coordinates>
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            <y>1.269</y>
            <z>2.45354</z>
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      </vertices>
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          <v3>3</v3>
        </triangle>
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        . . .
      </region>
    </mesh>
```

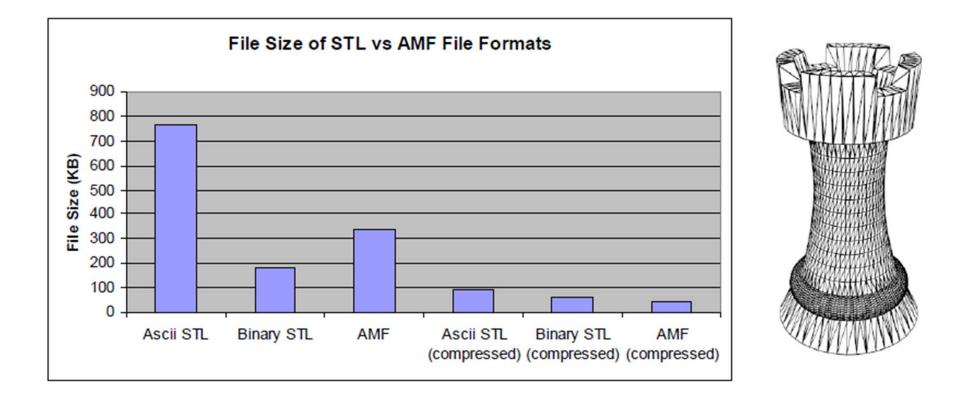
Basic AMF Structure



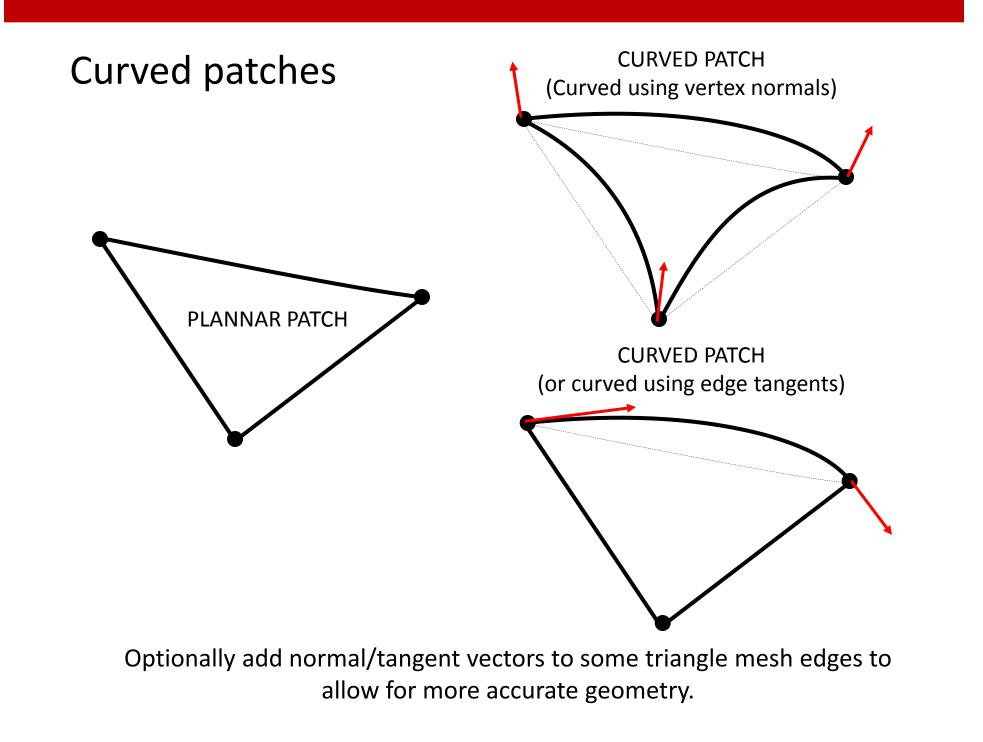
</object> Addresses vertex duplication and leaks of STL & Units!
</amf>



Compressibility



Comparison for 32-bit Floats; need to look at double precision



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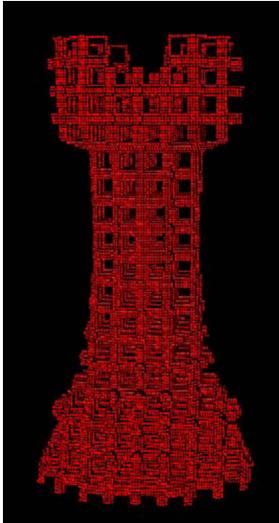
Gradient Materials



Multiple Materials



Microstructure





Color and Graphics

- Can be assigned to
 - A material
 - A region
 - A vertex
- Specified
 - Fixed RGBA values
 - By formula
 - By reference to an image



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Print Constellation

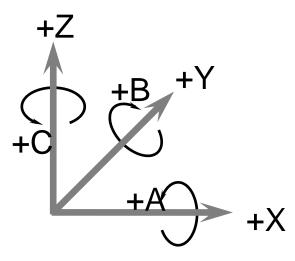
- Print orientation
- Duplicated objects
- Sets of different objects
- Efficient packing
- Hierarchical

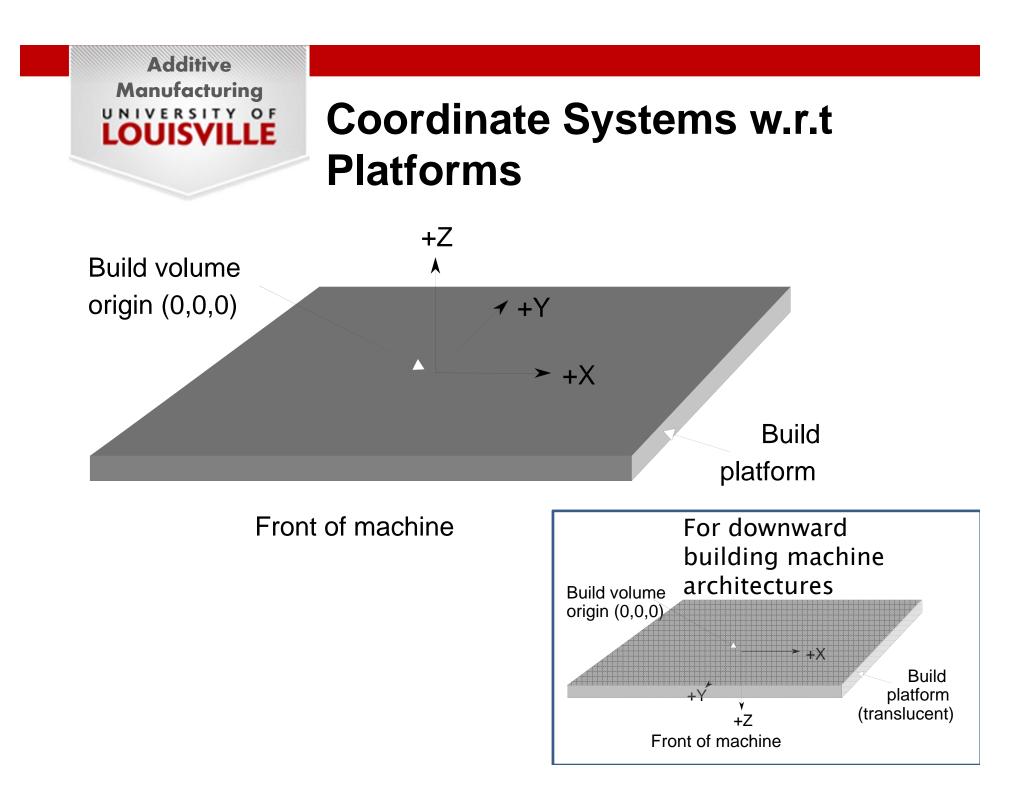


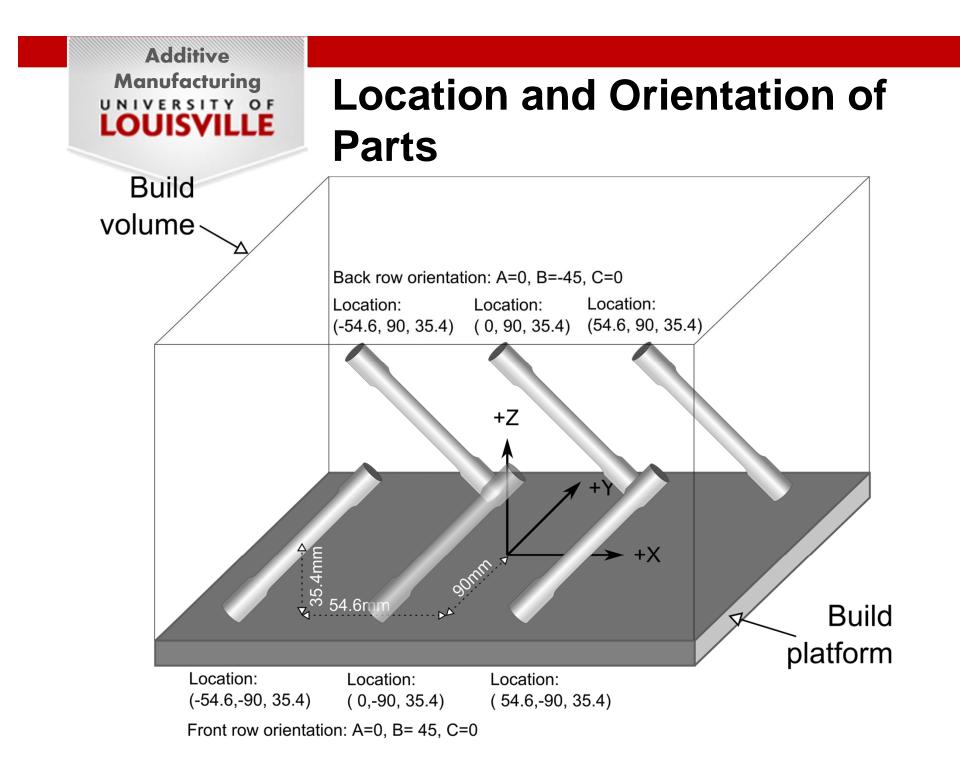


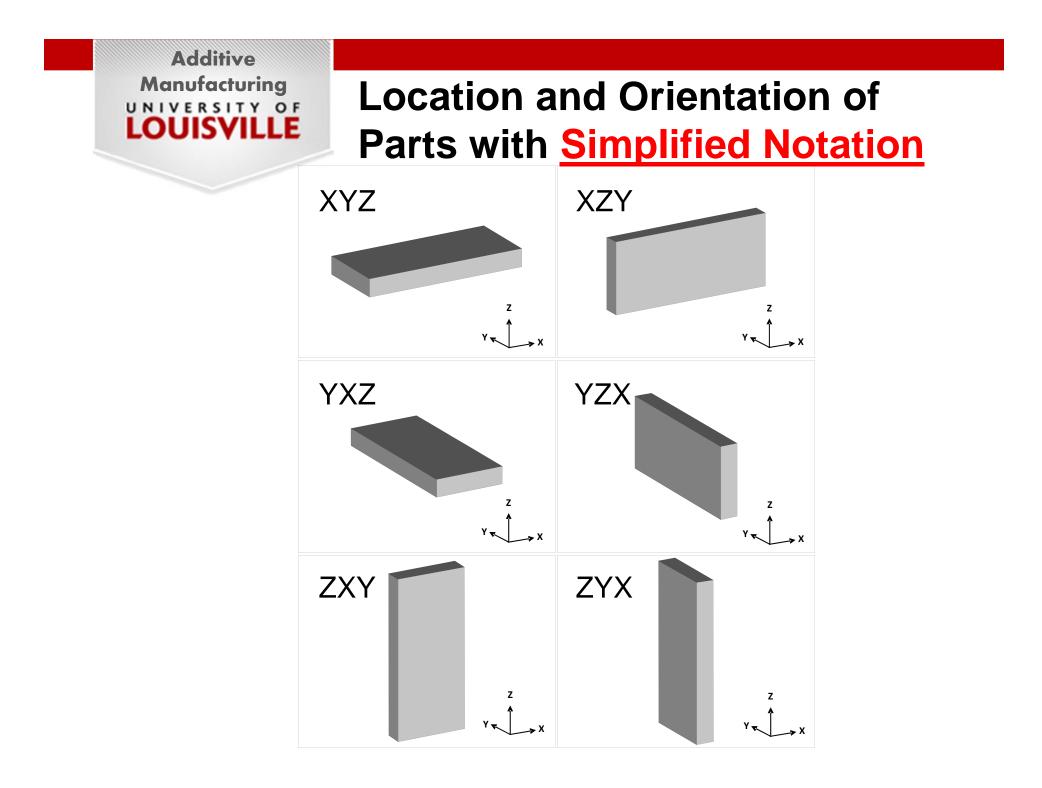
Testing

- Testing Terminology Standard
 - Standardized part orientation and location within a build
 - Based on basic coordinate systems as per ISO 841



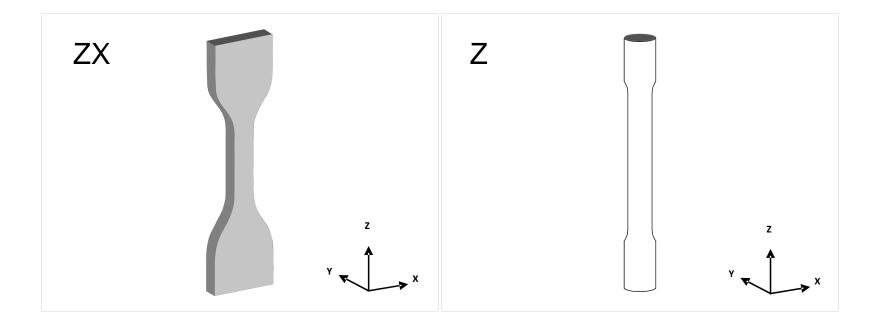








Location and Orientation of Parts with <u>Simplified Notation</u>





Materials & Processes Standards

- Powder Bed Fusion of Ti 6/4 standard (ASTM F2924)
 - Working on finalizing revision for ISO adoption
 - European members wanted to address alpha prime microstructures & other property considerations
 - Working on other metals
 - Ti 6/4 ELI, IN 718, IN 625, F75 (CoCr), etc.
- Polymer Powder Bed Fusion standard nearing completion for balloting



US TAG for TC 261

- Coordinating activity with ISO
 - Agreement to co-brand standards
- Working to fast-track adoption of F42 output
 - Terminology
 - Testing Terminology
 - Powder Bed Ti 6/4
 - AMF
- Trying to negotiate the politics of ISO & European priorities



Key Questions for the Future of AM Standards

- Five years from now, what do we want to have in place for AM standards?
- What impacts will these future standards have on AM users, vendors, and technology providers?
- What steps can we take now to ensure that AM standards achieve the biggest future impact?

Objective Today/Tomorrow: Help determine the priorities needed within ASTM F42 /ISO TC261 for AM standards



Why A Strategic Approach is Needed

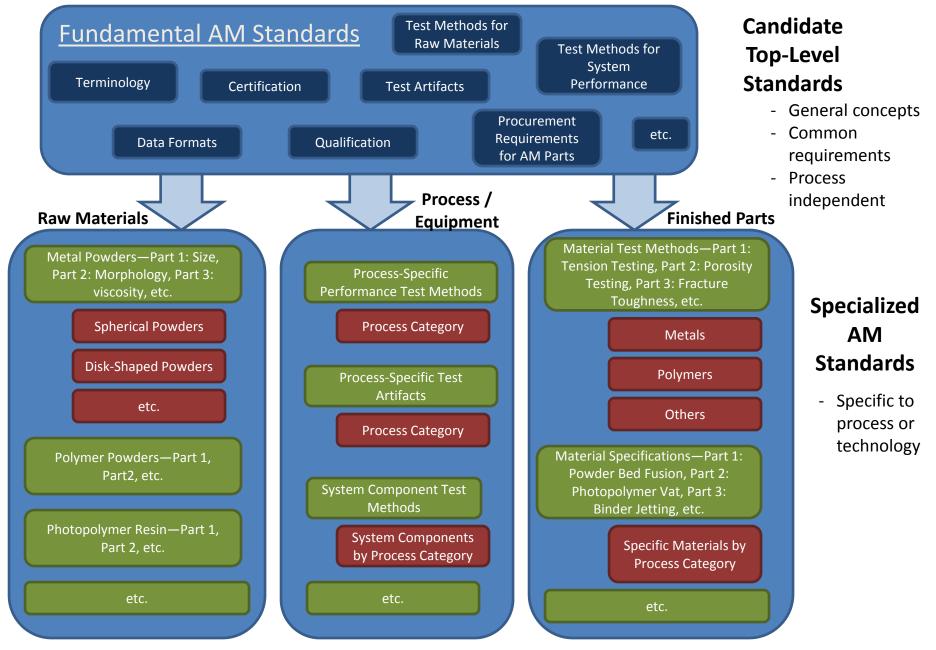
- To establish the overall structure and give guidance to task groups, helping with planning and prioritization
- To maximize the impact of the standards by:
 - Preventing overlap and contradiction among F42/TC261 standards
 - Ensuring that future standards work together as an integrated and cohesive set
 - Improving usability and acceptance for future users of all types (from the novice to the expert)



Proposed Strategic Approach

- Augment existing bottom-up approach with a top-down strategic view
 - Keep current progress and momentum intact, but provide structure for logical connections among standards
- Establish a top-level set of fundamental AM standards that address topics and issues common across many AM processes and applications
 - Related sets of specialized AM standards linked to the fundamental AM standards (reference and build on the concepts)
 - Specialized standards to address topics that are specific to a given AM process or technology

NIST Proposed General Structure





Benefits of Strategic Approach

- Efficient Reduces potential for redundancies and incompatibilities
- Consistent reduces potential need for future harmonization of contradictory standards
- Organized Prioritization and planning of standards development is easier, and relationships between standards are clear
- Includes and supplements current bottom-up approach



My Hopes for This Meeting

- A Top-Down Roadmap for Standards Development
 - High-level general standards and specific in-depth standard recommendations
- Recommendations for which task groups need to start work now



The Future of International Collaboration?

- We are at a turning point in our industry
 - 1. We are big enough that people care about us
 - Nationalism is increasingly apparent
 - Financial markets are starting to pay attention to us
 - 2. Monopolies are disappearing as patents expire
 - New **companies** and new **countries** can compete in the global marketplace
- I see companies and countries trying to lock other companies/countries out of certain AM technologies (and standards development activities).
- Will they succeed? I hope not!
 - "The cat is out of the bag..."



Questions & Comments?

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